



**THE DATASHEET OF
SIE808DF-T1-E3**

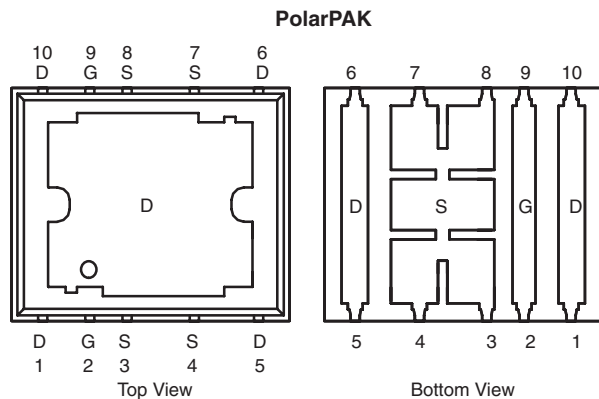


N-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|--------------------------------------|---------------------------------|---------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (Ω) ^e | I _D (A) ^a | | Q _g (Typ.) |
| | | Silicon Limit | Package Limit | |
| 20 | 0.0016 at V _{GS} = 10 V | 220 | 60 | 46 nC |
| | 0.0025 at V _{GS} = 4.5 V | 117 | 60 | |

Package Drawing

www.vishay.com/doc?72945



Top surface is connected to pins 1, 5, 6, and 10

Ordering Information: SiE808DF-T1-E3 (Lead (Pb)-free)
SiE808DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

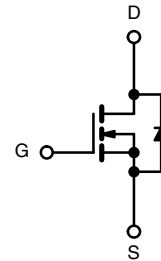
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Gen II Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{gd}/Q_{gs} Ratio Helps Prevent Shoot-Through
- 100 % R_g and UIS Tested
- Compliant to RoHS directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- VRM
- DC/DC Conversion: Low-Side
- Synchronous Rectification



N-Channel MOSFET
For Related Documents
www.vishay.com/ppg?73739

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | |
|---|-----------------------------------|---------------------------------|------|--|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 20 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | V | |
| Continuous Drain Current (T _J = 150 °C) | I _D | 220 (Silicon Limit) | A | |
| | | 60 ^a (Package Limit) | | |
| | | 60 ^a | | |
| | | 45 ^{b, c} | | |
| Pulsed Drain Current | I _{DM} | 100 | A | |
| | | 36 ^{b, c} | | |
| Continuous Source-Drain Diode Current | I _S | 60 ^a | A | |
| | | 4.3 ^{b, c} | | |
| Single Pulse Avalanche Current | I _{AS} | 35 | mJ | |
| Avalanche Energy | E _{AS} | 61 | | |
| Maximum Power Dissipation | P _D | 125 | W | |
| | | 80 | | |
| | | 5.2 ^{b, c} | | |
| | | 3.3 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | |
| Soldering Recommendations (Peak Temperature) ^{d, e} | | 260 | °C | |

Notes:

- Package limited is 60 A.
- Surface Mounted on 1" x 1" FR4 board.
- t = 10 s.
- See Solder Profile (www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

THERMAL RESISTANCE RATINGS

| Parameter | | Symbol | Typical | Maximum | Unit |
|---|---------------|---------------------|---------|---------|------|
| Maximum Junction-to-Ambient ^{a, b} | $t \leq 10$ s | R_{thJA} | 20 | 24 | °C/W |
| Maximum Junction-to-Case (Drain Top) | Steady State | R_{thJC} (Drain) | 0.8 | 1 | |
| Maximum Junction-to-Case (Source) ^{a, c} | | R_{thJC} (Source) | 2.2 | 2.7 | |

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
b. Maximum under Steady State conditions is 68 °C/W.
c. Measured at source pin (on the side of the package).

SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted

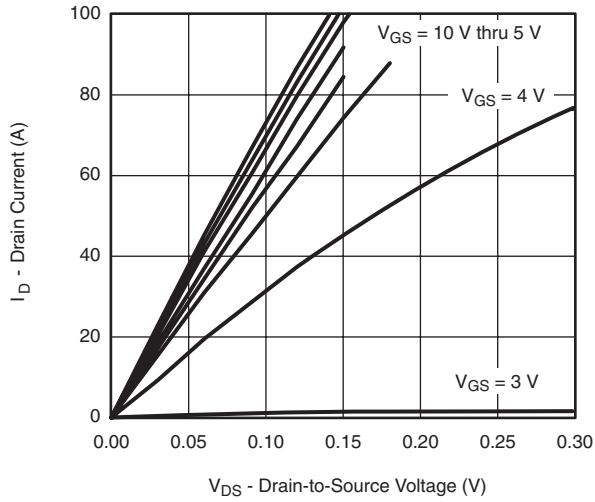
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|--|-------------------------|--|------|--------|-----------|----------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0$ V, $I_D = 250$ μ A | 20 | | | V |
| V_{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | $I_D = 250$ μ A | | 26.5 | | mV/°C |
| $V_{GS(th)}$ Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | -7.3 | | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250$ μ A | 1.5 | 2.3 | 3 | V |
| Gate-Source Leakage | I_{GSS} | $V_{DS} = 0$ V, $V_{GS} = \pm 20$ V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 20$ V, $V_{GS} = 0$ V | | | 1 | μ A |
| | | $V_{DS} = 20$ V, $V_{GS} = 0$ V, $T_J = 55$ °C | | | 10 | |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} \geq 5$ V, $V_{GS} = 10$ V | 25 | | | A |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | $V_{GS} = 10$ V, $I_D = 25$ A | | 0.0013 | 0.0016 | Ω |
| | | $V_{GS} = 4.5$ V, $I_D = 25$ A | | 0.0021 | 0.0025 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 10$ V, $I_D = 25$ A | | 95 | | S |
| Dynamic^b | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 10$ V, $V_{GS} = 0$ V, $f = 1$ MHz | | 8800 | | pF |
| Output Capacitance | C_{oss} | | 1600 | | | |
| Reverse Transfer Capacitance | C_{rss} | | 600 | | | |
| Total Gate Charge | Q_g | $V_{DS} = 10$ V, $V_{GS} = 10$ V, $I_D = 25$ A | | 102 | 155 | nC |
| | | $V_{DS} = 10$ V, $V_{GS} = 4.5$ V, $I_D = 20$ A | | 46 | 70 | |
| Q_{gs} | | | 26 | | | |
| Q_{gd} | | | 8 | | | |
| Gate Resistance | R_g | $f = 1$ MHz | | 0.9 | 1.35 | Ω |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 10$ V, $R_L = 1$ Ω $I_D \cong 10$ A, $V_{GEN} = 4.5$ V, $R_g = 1$ Ω | | 180 | 270 | ns |
| Rise Time | t_r | | | 215 | 325 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 50 | 75 | |
| Fall Time | t_f | | | 15 | 25 | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 10$ V, $R_L = 1$ Ω $I_D \cong 10$ A, $V_{GEN} = 10$ V, $R_g = 1$ Ω | | 25 | 40 | |
| Rise Time | t_r | | | 55 | 85 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 55 | 85 | |
| Fall Time | t_f | | | 10 | 15 | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous Source-Drain Diode Current | I_S | $T_C = 25$ °C | | | 60 | A |
| Pulse Diode Forward Current ^a | I_{SM} | | | | 100 | |
| Body Diode Voltage | V_{SD} | $I_S = 10$ A | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 10$ A, $di/dt = 100$ A/ μ s, $T_J = 25$ °C | | 56 | 85 | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | | | 60 | 90 | nC |
| Reverse Recovery Fall Time | t_a | | | 26 | | ns |
| Reverse Recovery Rise Time | t_b | | | 30 | | |

Notes:

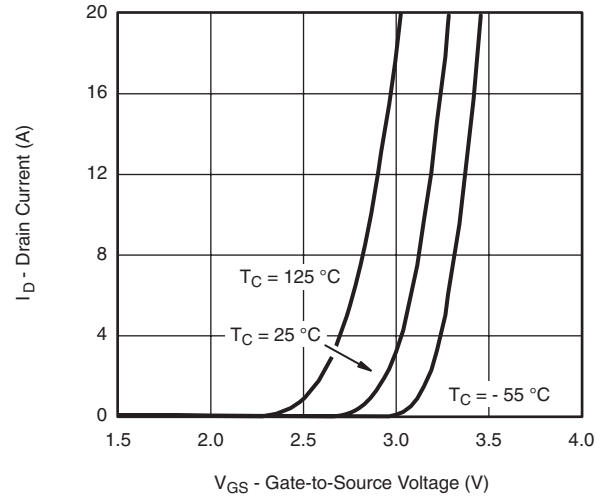
- a. Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

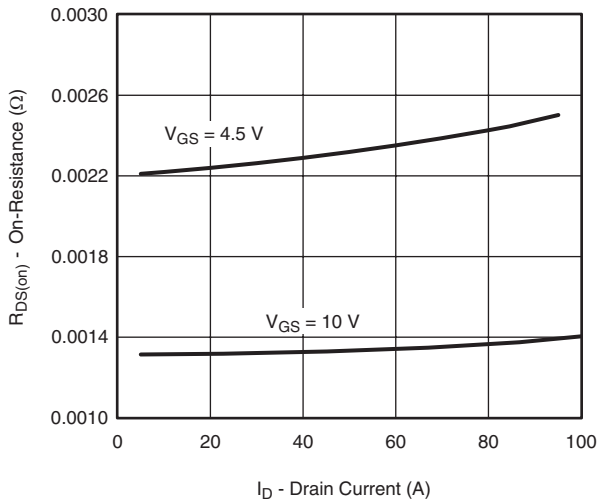
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



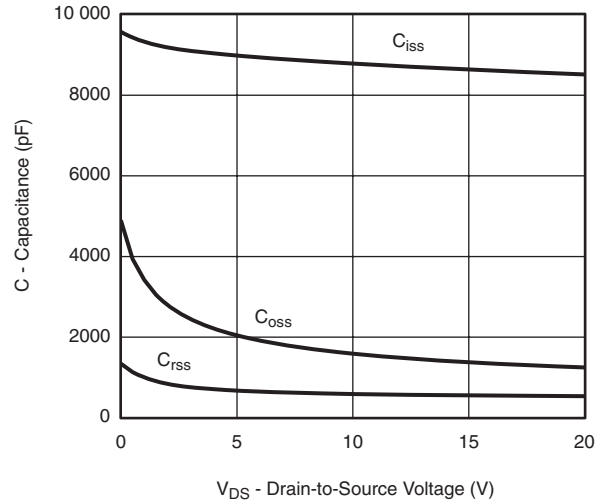
Output Characteristics



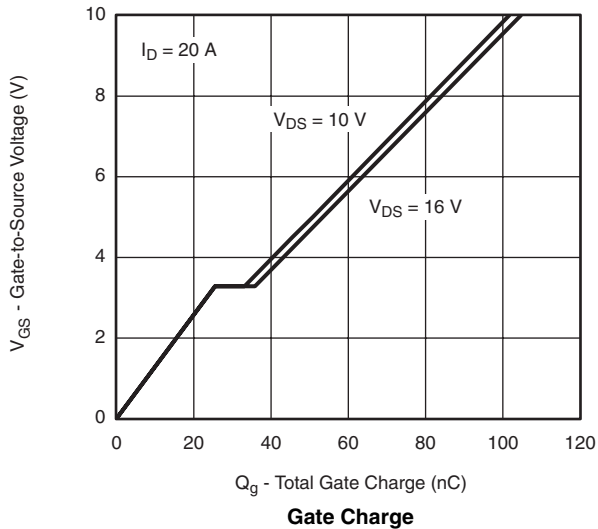
Transfer Characteristics



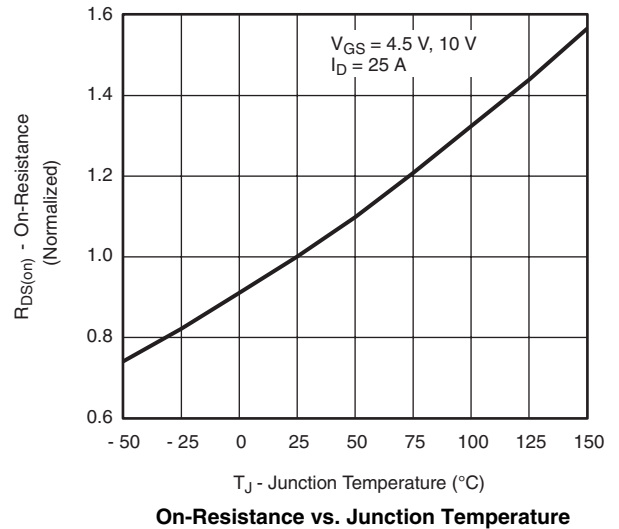
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

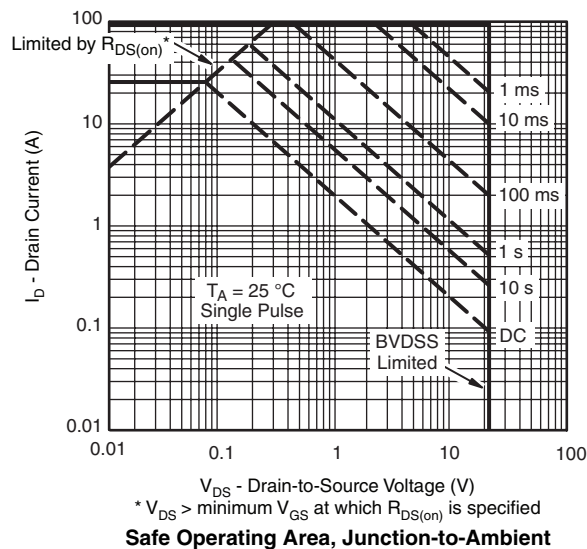
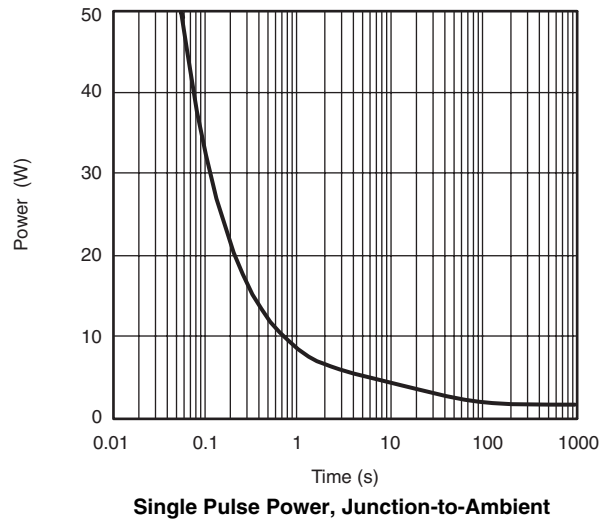
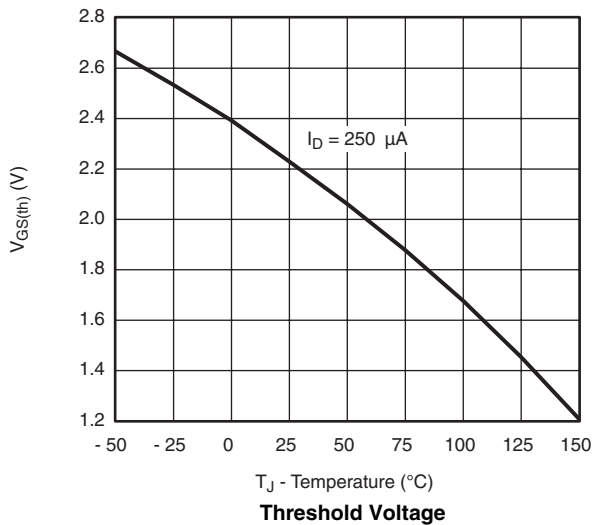
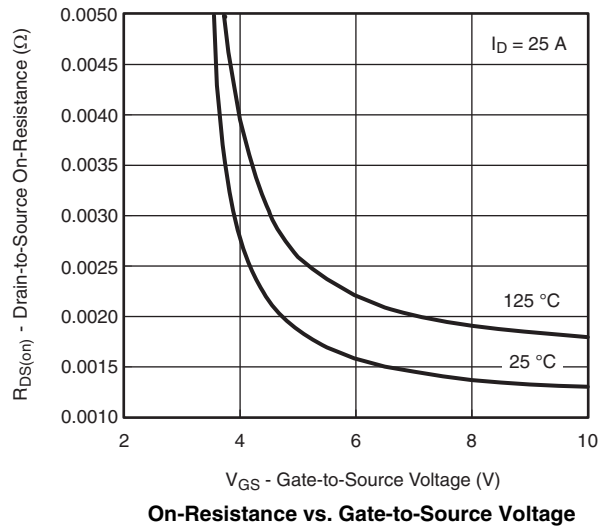
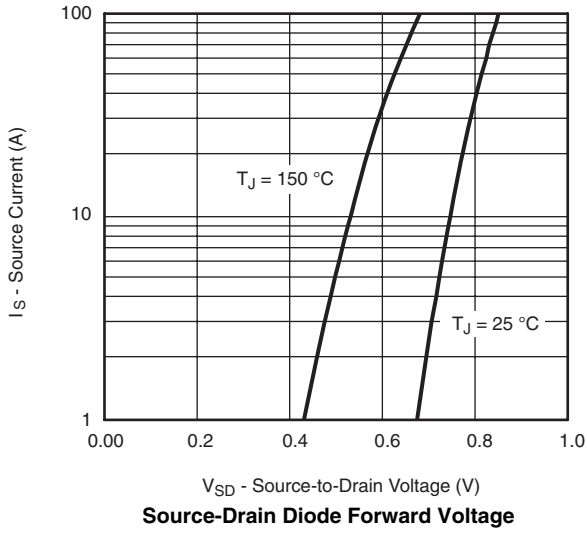


Gate Charge

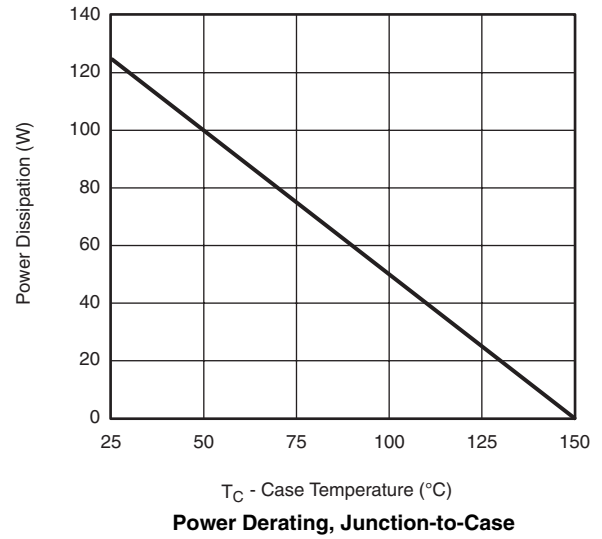
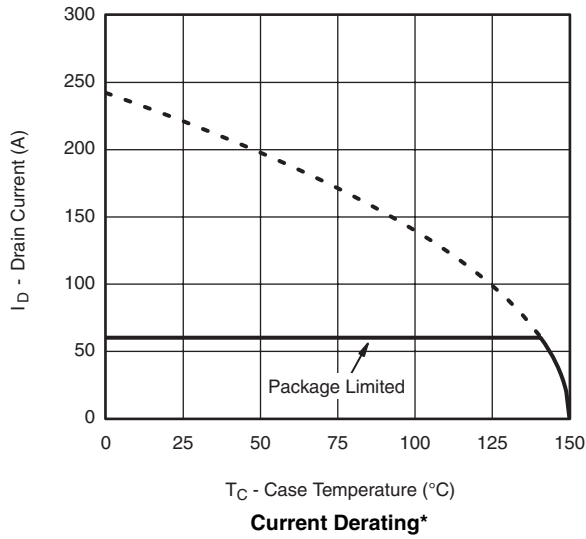


On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

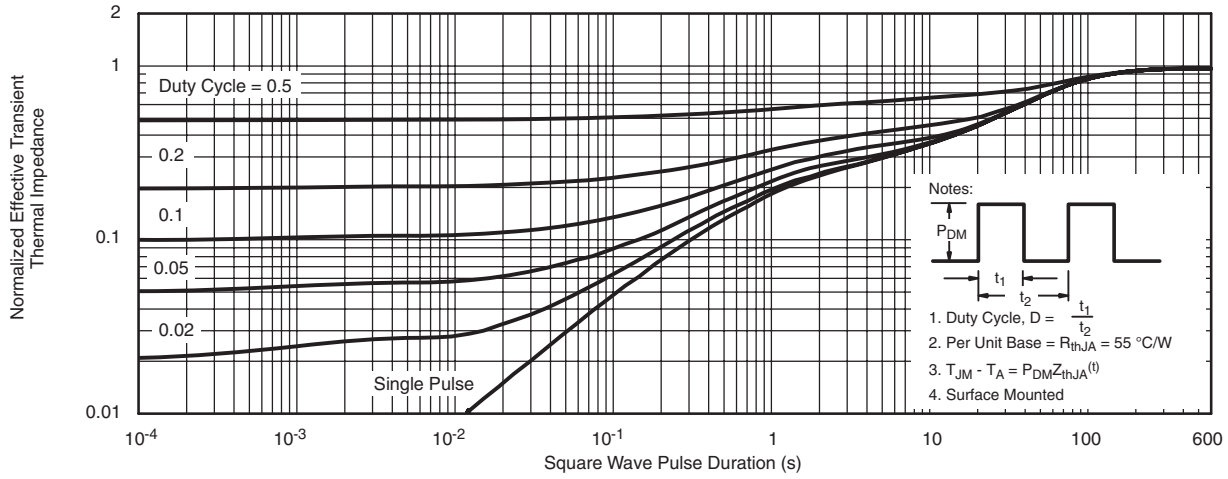


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

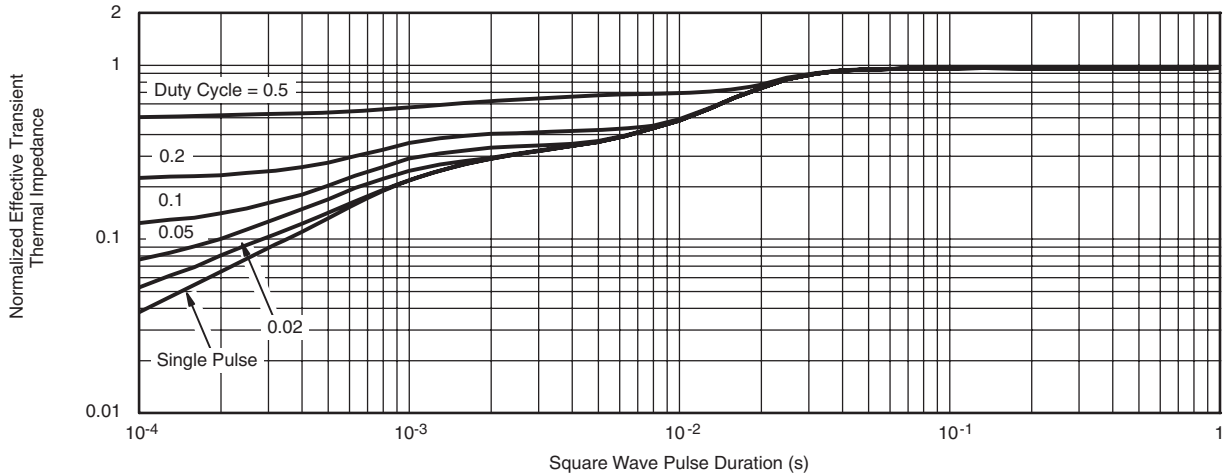


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

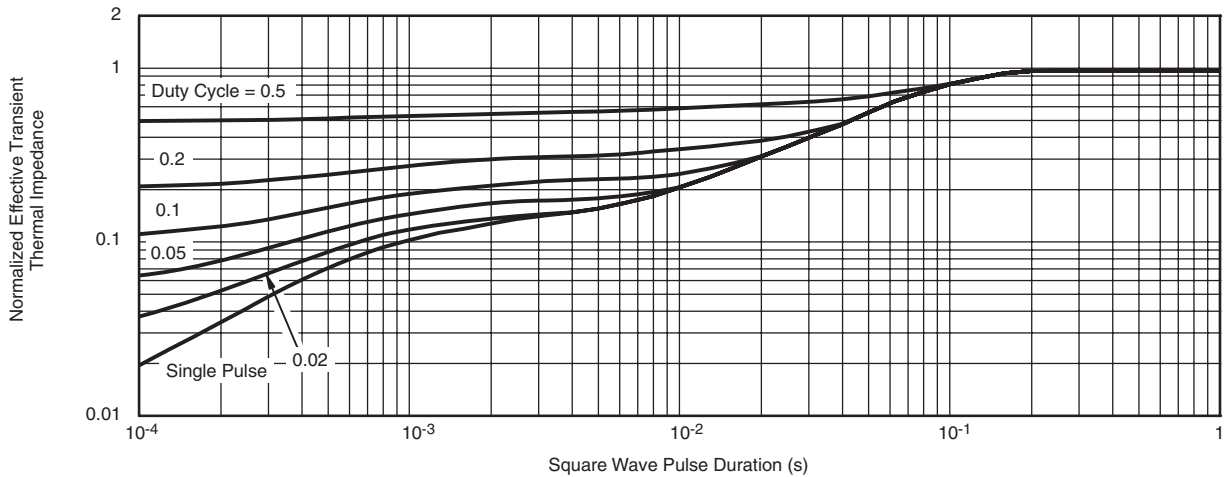
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



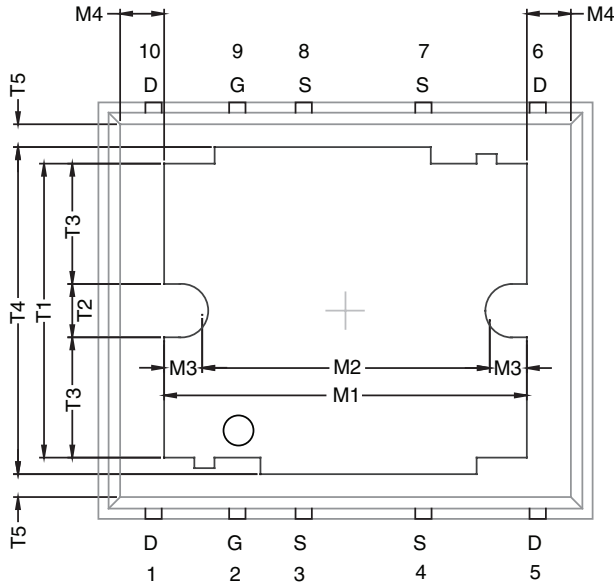
Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



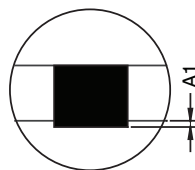
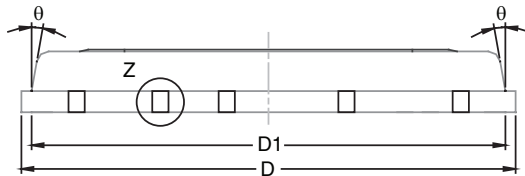
Normalized Thermal Transient Impedance, Junction-to-Source

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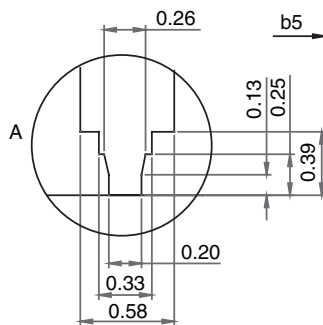
POLARPAK™ OPTION L



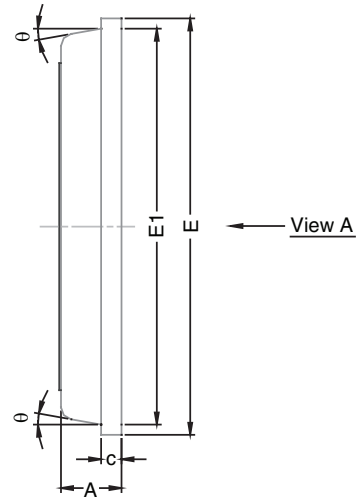
(Top View)



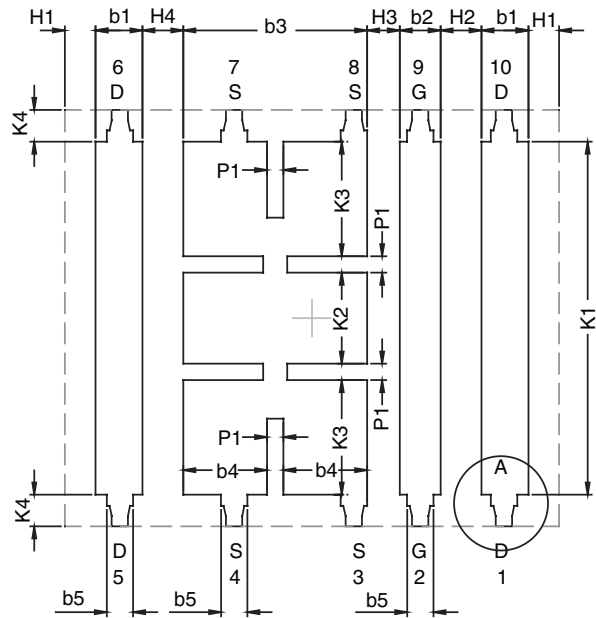
DETAIL Z



Product datasheet/information page contain links to applicable package drawing.



View A



View A
(Bottom View)

Package Information

Vishay Siliconix



| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.75 | 0.80 | 0.85 | 0.030 | 0.031 | 0.033 |
| A1 | 0.00 | - | 0.05 | 0.000 | - | 0.002 |
| b1 | 0.48 | 0.58 | 0.68 | 0.019 | 0.023 | 0.027 |
| b2 | 0.41 | 0.51 | 0.61 | 0.016 | 0.020 | 0.024 |
| b3 | 2.19 | 2.29 | 2.39 | 0.086 | 0.090 | 0.094 |
| b4 | 0.89 | 1.04 | 1.19 | 0.035 | 0.041 | 0.047 |
| b5 | 0.23 | 0.33 | 0.43 | 0.009 | 0.013 | 0.017 |
| c | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 |
| D | 6.00 | 6.15 | 6.30 | 0.236 | 0.242 | 0.248 |
| D1 | 5.74 | 5.89 | 6.04 | 0.226 | 0.232 | 0.238 |
| E | 5.01 | 5.16 | 5.31 | 0.197 | 0.203 | 0.209 |
| E1 | 4.75 | 4.90 | 5.05 | 0.187 | 0.193 | 0.199 |
| H1 | 0.23 | - | - | 0.009 | - | - |
| H2 | 0.45 | - | 0.56 | 0.018 | - | 0.022 |
| H3 | 0.31 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 |
| H4 | 0.45 | - | 0.56 | 0.018 | - | 0.022 |
| K1 | 4.22 | 4.37 | 4.52 | 0.166 | 0.172 | 0.178 |
| K2 | 1.08 | 1.13 | 1.18 | 0.043 | 0.044 | 0.046 |
| K3 | 1.37 | - | - | 0.054 | - | - |
| K4 | 0.24 | - | - | 0.009 | - | - |
| M1 | 4.30 | 4.50 | 4.70 | 0.169 | 0.177 | 0.185 |
| M2 | 3.43 | 3.58 | 3.73 | 0.135 | 0.141 | 0.147 |
| M3 | 0.22 | - | - | 0.009 | - | - |
| M4 | 0.05 | - | - | 0.002 | - | - |
| P1 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| T1 | 3.48 | 3.64 | 4.10 | 0.137 | 0.143 | 0.161 |
| T2 | 0.56 | 0.76 | 0.95 | 0.022 | 0.030 | 0.037 |
| T3 | 1.20 | - | - | 0.047 | - | - |
| T4 | 3.90 | - | - | 0.153 | - | - |
| T5 | 0 | 0.18 | 0.36 | 0.000 | 0.007 | 0.014 |
| θ | 0° | 10° | 12° | 0° | 10° | 12° |

ECN: T-08441-Rev. C, 11-Aug-08
DWG: 5946

Notes

Millimeters govern over inches.



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